

FIGURE 1
 (Prior Art)

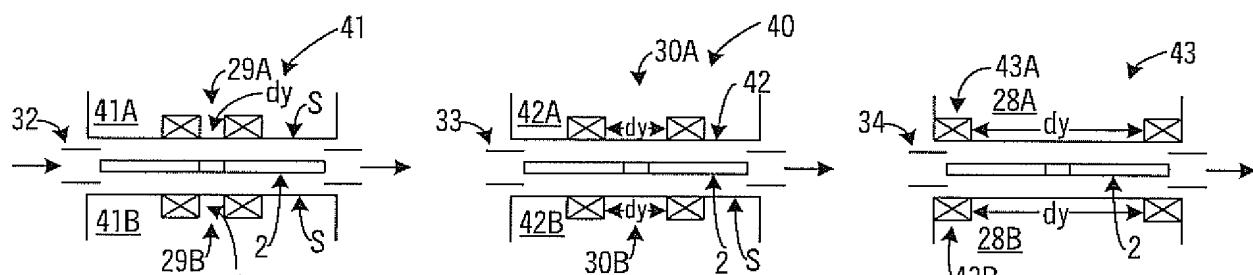


FIGURE 2(A)

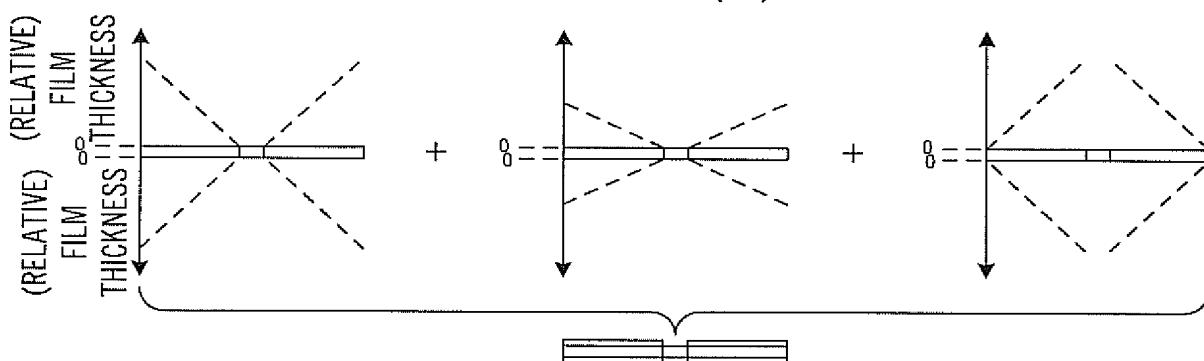
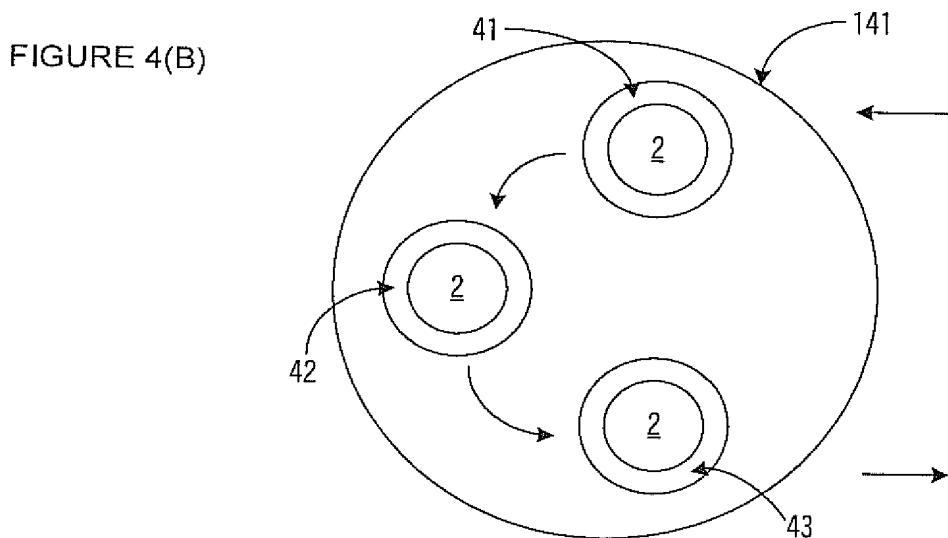
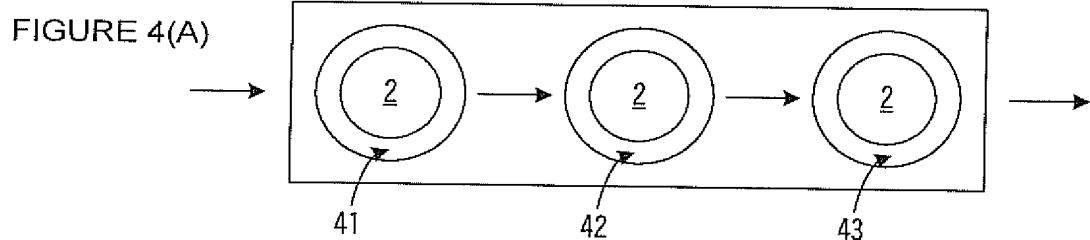
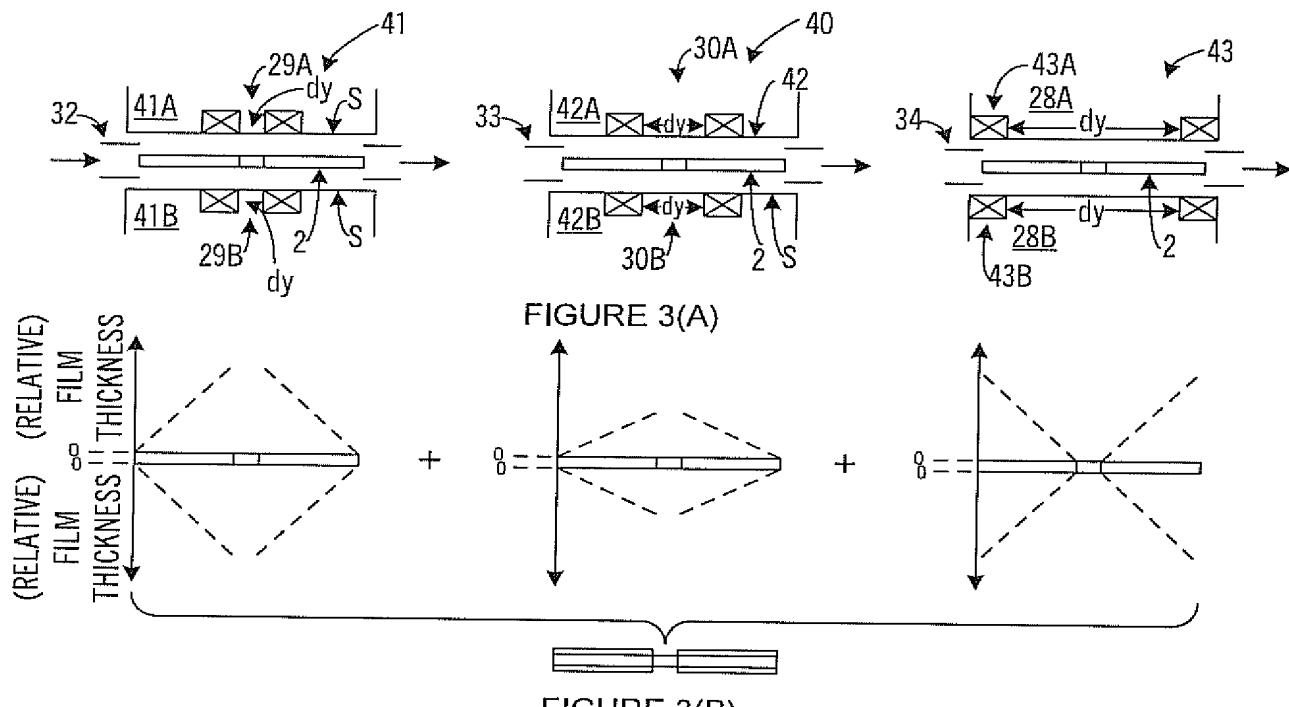


FIGURE 2(B)

TITLE: METHOD & APPARATUS FOR MULTI-STAGE SPUTTER DEPOSITION OF UNIFORM THICKNESS LAYERS

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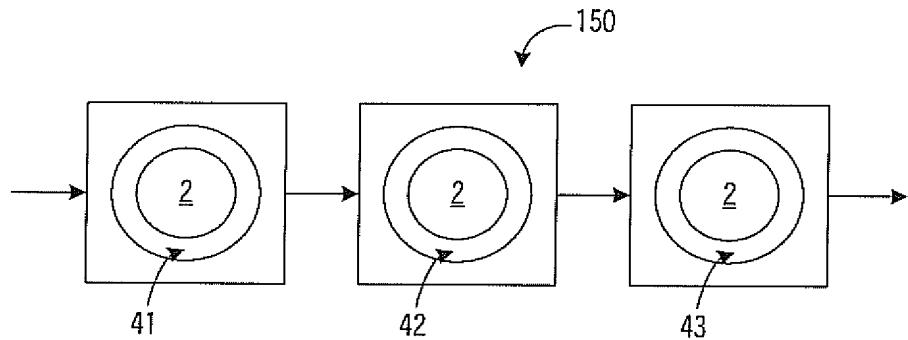


FIGURE 5(A)

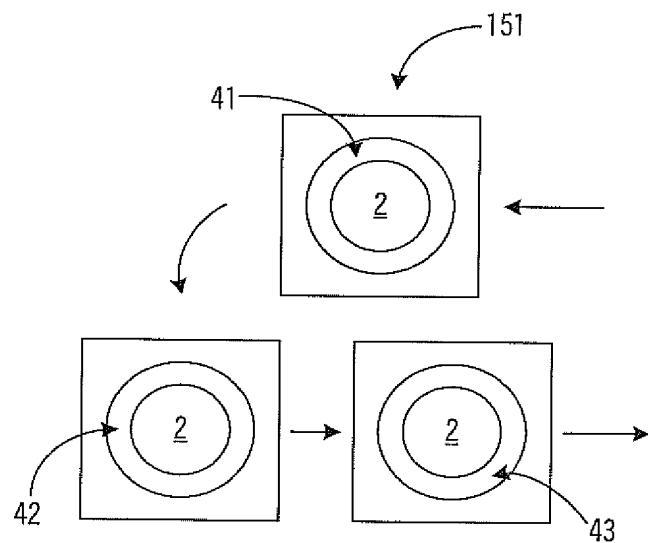


FIGURE 5(B)